

# PI6C3421A

## 27MHz Spread Spectrum Clock Synthesizer

## **Product Features**

- 14.318 MHz input frequency, (crystal or external reference)
- Two High Precision outputs: —27.000 MHz SSC clock output —27.000 MHz clock output
- Four Down-Spread options:
  Down-spread: -0.25%, -0.5%, -0.75% and -1.0% typical at 14.318MHz input
- Single 3.3V Power Supply
- Modulation Rate: Fin /448
- · Industrial and commercial temperature supported
- Packaging (Pb-Free and Green):
  SOTiny<sup>™</sup> 6-pin SOT23 (T)

#### Applications

The PI6C3421A can be used in most multimedia applications and embedded systems including but not limited to the following:

- PDAs
- DSCs
- Printers/ MFPs
- Media players
- Portable-TVs
- Embedded digital video devices
- CD-ROM, VCD and DVD players
- LCD Panel Modules
- Automotive components
- Networking devices

#### Benefits

- Reduction in EMI
- System cost saving
- Reduced system complexity
- Faster time to market

### **Block Diagram**



# Description

The PI6C3421A is a Spread Spectrum Clock Synthesizer and part of the Pericom SSCG product family. The part generates one high precision 27.000 MHz spread spectrum clock output from a single clock source or a crystal and one 27.000 MHz un-modulated clock output, and is designed to reduce electromagnetic interference (EMI) by spreading the clock. This reduction in EMI can result in significant system cost saving and less design complexity by reducing the number of circuit board layers ferrite beads and shielding. In the absence of a spread spectrum clock, other EMI-reducing components are required in order to comply with regulatory agency requirements.

The spreading ratio is selectable using the selection pins. The PI6C3421A provides -0.25%, -0.5%, -0.75% and -1.0% spread modulation through external logic stage setting. The variety and the reduced size of the package outlines can save precious board space and make layout easier.

PI6C3421A is one of the clock products provided by Pericom. If your application needs a clock product with a different specification not currently provided, please contact us for further information or custom design.

## **Pin Configuration**





## **Pin Description**

| Pin Name   | Pin No | І/О Туре | Description   |
|------------|--------|----------|---|
| X1/REFIN   | 1      | Ι        | Crystal or reference clock input                                  |
| GND        | 2      | Ground   | Ground  |
| 27M_SSC/S0 | 3      | I/O      | 27M_SSC/SO is a multi-functional pin. S0 is active during power   |
|            |        |          | on for spreading ratio selection then switches to 27MHz SSC clock |
|            |        |          | output.   |
| 27M        | 4      | 0        | 27MHz clock output.   |
| VDD        | 5      | Power    | Power Supply  |
| X2/S1      | 6      | I/O      | X2/S1 is a multiple function pin. S1 is active during power on    |
|            |        |          | selection of SSC spread then switches to crystal input.           |

## **Spread Ration Configuration**

 $(V_{DD} = 3.3V \pm 10\%, \text{Ambient Temperature} = 25^{\circ}\text{C}, f_{OUT} = 27 \text{ MHz})$ 

| S0 | <b>S</b> 1 | Down - Spread(%) |
|----|------------|------------------|
| 0  | 0          | -0.25            |
| 0  | 1          | -0.5             |
| 1  | 0          | -0.75            |
| 1  | 1          | -1.0             |



# **Electrical Specifications**

## Maximum Ratings<sup>(1)</sup>

| Supply Voltage to Ground |                                |
|--------------------------|--------------------------------|
| All Inputs and Outputs   | -0.5V to V <sub>DD</sub> +0.5V |
| Storage Temperature      | -65°C to +150°C                |
| Operating Temperature    | -40 to +85°C                   |
| Junction Temperature     | 150°C                          |
| Soldering Temperature    |                                |
| 1                        |                                |

1. Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indi-

for extended periods may affect reliability.

cated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions

Note:

**DC Characteristics** ( $V_{DD}$  = 3.3V ±10%, Ambient Temperature -40°C to +85°C, f<sub>IN</sub> = 14.318 MHz)

| Symbol               | Parameter                | Conditions                                   | Min. | <b>Typ.</b> <sup>(1)</sup> | Max. | Unit |
|----------------------|--------------------------|--|------|----------------------------|------|------|
| V <sub>DD</sub>      | Operating Voltage        |  | +3.0 | +3.3                       | +3.6 | V    |
| V <sub>IH</sub>      | Input High Voltage       |  | 2    |                            |      | V    |
| V <sub>IL</sub>      | Input Low Voltage        |  |      |                            | 0.8  | V    |
| V <sub>OH</sub>      | Output High Voltage      | $I_{OH} = -4 \text{ mA}$                     | 2.4  |                            |      | V    |
| V <sub>OH</sub>      | Output High Voltage      | $I_{OH} = -6 \text{ mA}$                     | 2.0  |                            |      | V    |
| V <sub>OL</sub>      | Output Low Voltage       | $I_{OL} = 4 \text{ mA}$                      |      |                            | 0.4  | V    |
| V <sub>OL</sub>      | Output Low Voltage       | $I_{OL} = 6 \text{ mA}$                      |      |                            | 0.6  | V    |
| I <sub>DD</sub>      | Supply Current           | All outputs active with $C_{L} = 15 pF$ load |      |                            | 55   | mA   |
| Z <sub>OUT_UP</sub>  | Nominal Output Impedance | High side buffer                             |      | 65                         |      | Ω    |
| Z <sub>OUT_LOW</sub> | Nominal Output Impedance | Low side buffer                              |      | 40                         |      | Ω    |
| C <sub>IN</sub>      | Input Capacitance        | Input pins                                   |      | 6                          |      | pF   |

AC Characteristics ( $V_{DD} = 3.3V \pm 10\%$ , Ambient Temperature  $-40^{\circ}$ C to  $+85^{\circ}$ C)

| Symbol            | Parameter                                    | Conditions   | Min. | <b>Typ.</b> <sup>(1)</sup> | Max. | Unit |
|-------------------|--|--|------|----------------------------|------|------|
| f <sub>IN</sub>   | REFIN Input Frequency                        | REFIN Clock Input  | 8    | 14.318                     | 24.5 | MHz  |
| fout              | Clock Output Frequency                       | Multiplication factor ( $f_{IN}/f_{OUT} = 1.885715$ )          | 15.1 | 27                         | 46.2 | MHz  |
| t <sub>RISE</sub> | Output Clock Rise Time                       | From 0.4V to 2.4V, $C_L = 15$ pF load                          |      | 3                          |      | ns   |
| tFALL             | Output Clock Fall Time                       | From 2.4V to 0.4V, $C_L = 15$ pF load                          |      | 2.7                        |      | ns   |
| TJ_SHORT          | Short term jitter                            | Cycle-to-cycle jitter ( $f_{OUT} = 27 \text{ MHz}$ )           |      | 250                        | 350  | ps   |
| T <sub>IDC</sub>  | Input Clock Duty Cycle                       | REFIN/X1, Measured @ $V_{DD}/2$ (f <sub>OUT</sub> = 27 MHz)    | 20   | 50                         | 80   | %    |
| T <sub>ODC</sub>  | Output Clock Duty<br>Cycle                   | Measured @ $V_{DD}/2$ (f <sub>OUT</sub> = 27 MHz)              | 45   | 50                         | 55   | %    |
| $\Delta f/f$      | Actual mean frequency<br>error versus target | Input frequency = 14.31818 MHz, Output fre-<br>quency = 27 MHz |      | 0                          |      | ppm  |

Note:

1. Typical conditions are at 3.3V for room temperature at 25°C



# **Application Information**

## **Decoupling Capacitor**

Two decoupling capacitors of 0.1uF and 1nF must be connected in parallel between VDD and GND. To optimize device performance and to lower output noise, the coupling capacitors should be placed on the component side of the board as close to these pins as possible. There should be no vias placed between the decoupling capacitors and VDD pin. The PCB trace to VDD pin should be as short as possible, and no vias should be placed between VDD and the capacitors in the decoupling circuit.  $10k\Omega$  to  $50k\Omega$  pull-up or pull-down resistors, depending on the application, should be used on S0 and S1 to select the logical state and corresponding spreading ratio.



1. PI6C3421A can accept a 14.31818 MHz reference clock or crystal clock.

2. Power supply pin decoupling capacitors should be placed as close as possible to VDD pin. Via's at the VDD pin should be avoided.

 Spread select pin's (S0 and S1): Pin 3 (27M\_SSC/S0) and Pin 6 (X2/S1) provide logic state strapping function. When strapping resistor connects to VDD, S0 and S1 are set to logic HIGH. When strapping resistor connects to Ground, S0 or S1 will set to logic LOW.

4. Refer to "Spread Spectrum Selection Table", for more details on the strapping logic.

## **Crystal Load Capacitors**

If a crystal is used with the device, the external trim capacitors CLtrim are used to adjust the effective capacitance to match the required crystal load capacitance. The CLtrim value can be derived from formula CLtrim = 2\*CL - (Cs + Ci). Typical CLtrim = 28pF when crystal load = 18pF, stray capacitance  $C_s = 3pF$  and XTAL pins capacitance = 5pF.



## **Series Termination Resistor**

For optimal performance, a series termination resistor should be used, when the PCB trace between the clock output and the load is over 1 inch. A 10 $\Omega$  resistor should be used to series terminate a 50 $\Omega$  trace, a typical trace impedance found on PCB boards. The series termination resistor should be placed in series and as close to the clock output as possible. The nominal impedance measured at the clock output of the part is 40 $\Omega$ .

## **PCB Layout Recommendation**

To optimize device performance, all components should be placed on the same side of the board and, therefore, no vias are used through other signal layers. The part should be kept away from other signal traces including ones just underneath the part or on layers adjacent to the ground plane layer used by the part. The PCB trace from the part to the ground via should be kept as short as possible

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# **Recommended Crystal Specification**

Pericom recommends SRX7316-E Crystal for optimum performance.

| Parameter                      | Value                                | Units    |  |
|--------------------------------|--------------------------------------|----------|--|
| Mode of oscillation, and cut   | Fundamental AT                       |          |  |
| Frequency                      | 14.318                               | MHz      |  |
| Frequency Tolerance            | ±20                                  | PPM      |  |
| Temperature                    | ±30                                  | PPM      |  |
| Load Cap                       | 18                                   | pF       |  |
| Equivalent series resistance   | 40                                   | Ω        |  |
| Drive to level                 | 100                                  | μW       |  |
| Aging Stability                | ±5                                   | PPM/YR   |  |
| Size (Length x Width x Height) | 11.18(.440) x 4.65(.83) x 13.46(.53) | mm(inch) |  |



Packaging Mechanical: 6-Pin, SOT23



09-0131

Note:

For latest package info, please check: http://www.pericom.com/products/packaging/mechanicals.php

## **Ordering Information**<sup>(1-3)</sup>

| Ordering Code | Package Code | РаскадеТуре                  |
|---------------|--------------|------------------------------|
| PI6C3421ATEX  | Т            | Pb-free & Green, 6-Pin SOT23 |
| PI6C3421AITEX | Т            | Pb-free & Green, 6-Pin SOT23 |

Notes:

1. Thermal characteristics and package top marking information can be found at http://www.pericom.com/packaging/

2. I= Industrial Temperature  $(-40 \sim +85^{\circ}C)$ 

3. E=Pb-free and Green package

4. Adding an X suffix=Tape/Reel

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